

Receipt
#6

PATENT

Docket No. 420099-654

LSI Ref. P-2880/1D

I hereby certify that this correspondence is being deposited on December 29, 1997 with the United States Postal Service as first class mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231.

Cheryle A. Healion

Cheryle A. Healion

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Mike Liang

Entitled: **FLIP CHIP BUMP
DISTRIBUTION ON DIE**

Serial No.: 08/909,312

Filed: August 14, 1997

Group Art Unit: 110

Examiner:

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MAR 6 2 1998

GROUP 2100

Assistant Commissioner for Patents
Washington, D.C. 20231
Attn: Application Processing Division
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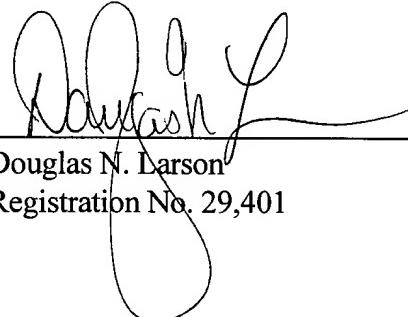
FILING RECEIPT CORRECTION

Sir:

Please correct the filing receipt (copy enclosed and corrections indicated in red) related to the above-referenced patent application. The Filing Date as shown on the filing receipt is "08/11/97" and should be changed to indicate the correct Filing Date as --08/14/97--.

PATENT
Docket No. 420099-654
LSI Ref. P-2880/1D

Respectfully submitted,

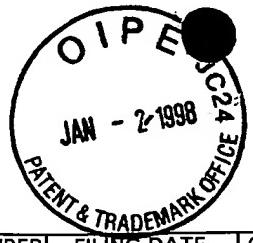


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Dated: December 29, 1997

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FILING RECEIPT



UNITED STATES DEPARTMENT OF COMMERCE
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| APPLICATION NUMBER | FILING DATE | GRP ART UNIT | FIL FEE REC'D | ATTORNEY DOCKET NO. | DRWGS | TOT CL | IND CL |
|--------------------|-------------|--------------|---------------|---------------------|-------|--------|--------|
| 08/909,312 | 08/11/97 | 1104 | \$770.00 | 420099-654 | 10 | 4 | 2 |

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Receipt is acknowledged of this nonprovisional Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Application Processing Division's Customer Correction Branch within 10 days of receipt. Please provide a copy of the Filing Receipt with the changes noted thereon.

Applicant(s)
MIKE LIANG, MILPITAS, CA.

CONTINUING DATA AS CLAIMED BY APPLICANT-
THIS APPLN IS A DIV OF 08/747,325 11/12/96

FOREIGN FILING LICENSE GRANTED 12/12/97

TITLE
FLIP CHIP BUMP DISTRIBUTION ON DIE

PRELIMINARY CLASS: 438